

4AK25

Silicon N Channel Power MOS FET Array

Application

High speed power switching

Features

- Low on-resistance
 $R_{DS(on)} \leq 0.45\Omega$, $V_{GS} = 10V$, $I_D = 1A$
- Low drive current
- High speed switching
- High density mounting

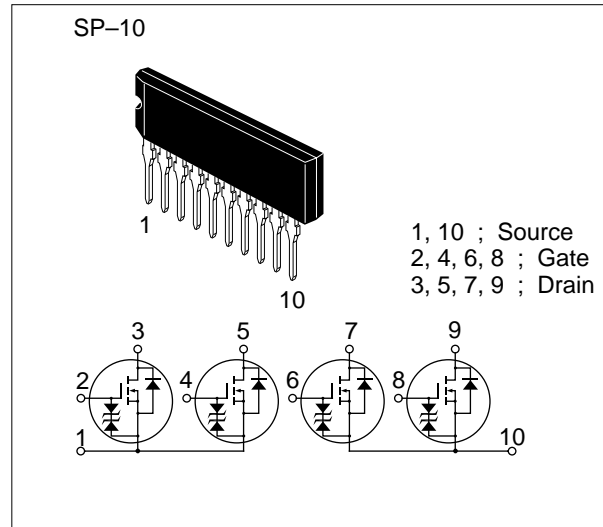


Table 1 Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	60	V
Gate to source voltage	V_{GSS}	± 20	V
Drain current	I_D	1.5	A
Drain peak current	$I_{D(pulse)^*}$	4.5	A
Body-drain diode reverse drain current	I_{DR}	1.5	A
Channel dissipation	$P_{ch}(T_c = 25^\circ\text{C})^{**}$	2.4	W
Channel dissipation	P_{ch}^{**}	3.6	W
Channel temperature	T_{ch}	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

* $PW \leq 10 \mu\text{s}$, duty cycle $\leq 1\%$

** 4 Devices operation

Table 2 Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	60	—	—	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	—	—	V	$I_G = \pm 100 \text{ } \mu\text{A}, V_{DS} = 0$
Gate to source leak current	I_{GSS}	—	—	±10	μA	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	250	μA	$V_{DS} = 50 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.0	—	2.0	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source on state resistance	$R_{DS(on)}$	—	0.35	0.45	Ω	$I_D = 1 \text{ A}$ $V_{GS} = 10 \text{ V}^*$
		—	0.47	0.65	Ω	$I_D = 1 \text{ A}$ $V_{GS} = 4 \text{ V}^*$
Forward transfer admittance	$ y_{fs} $	0.9	1.5	—	S	$I_D = 1 \text{ A}$ $V_{DS} = 10 \text{ V}^*$
Input capacitance	C_{iss}	—	140	—	pF	$V_{DS} = 10 \text{ V}$
Output capacitance	C_{oss}	—	70	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	C_{rss}	—	20	—	pF	$f = 1 \text{ MHz}$
Turn-on delay time	$t_{d(on)}$	—	3	—	ns	$I_D = 1 \text{ A}$
Rise time	t_r	—	12	—	ns	$V_{GS} = 10 \text{ V}$
Turn-off delay time	$t_{d(off)}$	—	50	—	ns	$R_L = 30 \text{ } \Omega$
Fall time	t_f	—	30	—	ns	
Body-drain diode forward voltage	V_{DF}	—	1.1	—	V	$I_F = 1.5 \text{ A}, V_{GS} = 0$
Body-drain diode reverse recovery time	t_{rr}	—	70	—	μs	$I_F = 1.5 \text{ A}, V_{GS} = 0,$ $dI_F / dt = 50 \text{ A} / \mu\text{s}$

* Pulse Test

See characteristic Curves of 2SK975

